TOSHIBA

MICROWAVE SEMICONDUCTOR TECHNICAL DATA

MICROWAVE POWER GaAs FET TIM6472-16UL

FEATURES

HIGH POWER

P1dB=42.5dBm at 6.4GHz to 7.2GHz

■ HIGH GAIN G1dB= 9.5dB at 6.4GHz to 7.2GHz BROAD BAND INTERNALLY MATCHED FET

■ HERMETICALLY SEALED PACKAGE

RF PERFORMANCE SPECIFICATIONS (Ta= 25°C)

				1	
SYMBOL	CONDITIONS	UNIT	MIN.	TYP.	MAX.
P1dB		dBm	41.5	42.5	
G1dB	VDS= 10V	dB	8.5	9.5	
	IDSset=3.6A				
IDS1	f = 6.4 to 7.2GHz	А		4.4	5.0
ΔG		dB			±0.6
ηadd		%		36	
IM3	Two-Tone Test	dBc	-44	-47	
	Po= 31.5dBm				
IDS2	(Single Carrier Level)	А		4.4	5.0
∆Tch	(VDS X IDS + Pin – P1dB) X Rth(c-c)	°C			80
	P1dB G1dB IDS1 ΔG ηadd IM3 IDS2	P1dBG1dBVDS= 10VIDS1IDSset=3.6AIDS1 $f = 6.4$ to 7.2GHz ΔG IM3IM3Two-Tone TestIDS2(Single Carrier Level) ΔTch (VDS X IDS + Pin - P1dB)	P1dBdBmG1dBVDS= 10VdBIDSIDSset=3.6AIDSIDS1f = 6.4 to 7.2GHzA ΔG dB ηadd %IM3Two-Tone TestdBcIDS2(Single Carrier Level)A ΔTch (VDS X IDS + Pin - P1dB) $\circ C$	P1dB dBm 41.5 G1dB VDS= 10V dB 8.5 IDSset=3.6A IDSset=3.6A IDS IDS1 f = 6.4 to 7.2GHz A	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

Recommended gate resistance(Rg) : Rg= 100 Ω(MAX.) ELECTRICAL CHARACTERISTICS (Ta= 25°C)

CHARACTERISTICS	SYMBOL	CONDITIONS	UNIT	MIN.	TYP.	MAX.
Transconductance	gm	VDS= 3V	mS		3600	
		IDS= 6.0A				
Pinch-off Voltage	VGSoff	VDS= 3V	V	-1.0	-2.5	-4.0
		IDS= 60mA				
Saturated Drain Current	IDSS	VDS= 3V	Α		10.5	
		VGS= 0V				
Gate-Source Breakdown	VGSO	IGS= -200µA	V	-5		
Voltage						
Thermal Resistance	Rth(c-c)	Channel to Case	∘C/W		1.5	1.8

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The information contained herein is subject to change without prior notice. It is therefor advisable to contact TOSHIBA before proceeding with design of equipment incorporating this product.

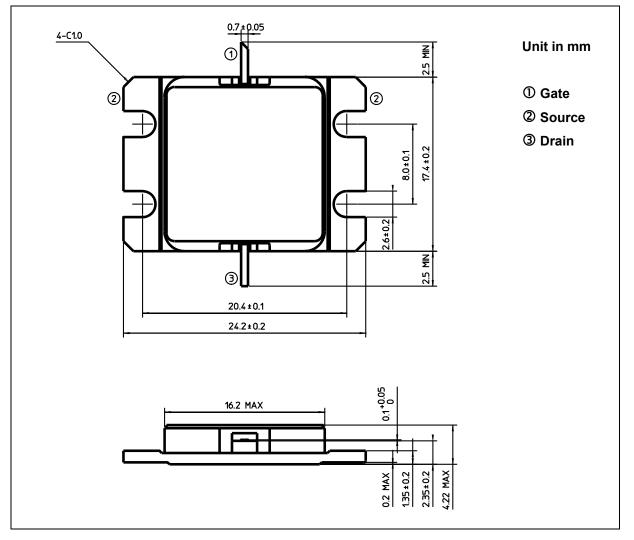
TOSHIBA CORPORATION

TIM6472-16UL

ABSOLUTE MAXIMUM RATINGS (Ta= 25°C)

CHARACTERISTICS	SYMBOL	UNIT	RATING
Drain-Source Voltage	VDS	V	15
Gate-Source Voltage	VGS	V	-5
Drain Current	IDS	А	14
Total Power Dissipation (Tc= 25 °C)	PT	W	83.3
Channel Temperature	Tch	°C	175
Storage	Tstg	°C	-65 to +175

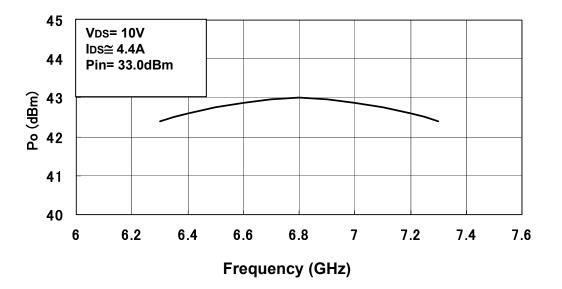
PACKAGE OUTLINE (2-16G1B)



HANDLING PRECAUTIONS FOR PACKAGE MODEL

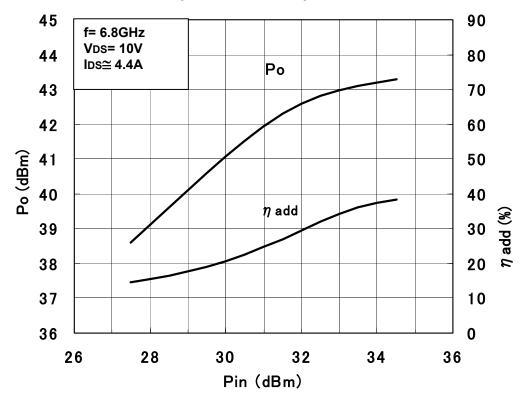
Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

RF PERFORMANCE

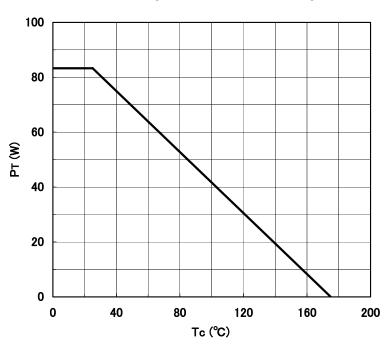


Output Power vs. Frequency





TIM6472-16UL ·



Power Dissipation vs. Case Temperature



